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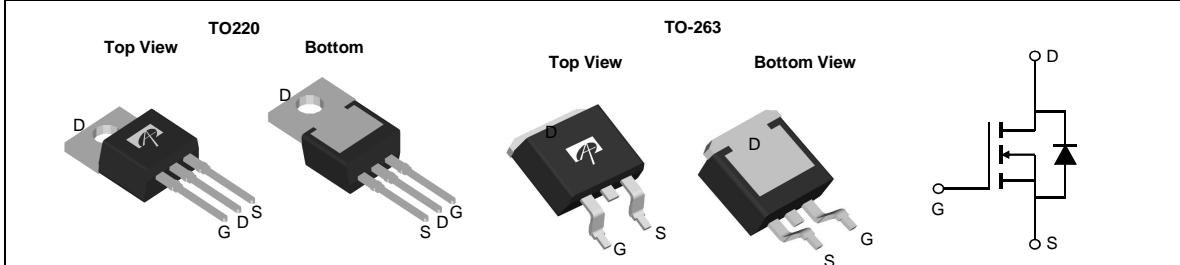
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[AOT270L](#)

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 ALPHA & OMEGA <i>SEMICONDUCTOR</i>	AOT270L/AOB270L <i>75V N-Channel MOSFET</i>								
General Description <p>The AOT270L/AOB270L uses Trench MOSFET technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$, Ciss and Coss. This device is ideal for boost converters and synchronous rectifiers for consumer, telecom, industrial power supplies and LED backlighting.</p>	Product Summary <table style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 50%;">V_{DS}</td><td style="width: 50%;">75V</td></tr> <tr> <td>I_D (at $V_{GS}=10V$)</td><td>140A</td></tr> <tr> <td>$R_{DS(ON)}$ (at $V_{GS}=10V$)</td><td>< 2.6mΩ (< 2.3mΩ*)</td></tr> <tr> <td>$R_{DS(ON)}$ (at $V_{GS}=6V$)</td><td>< 3.0mΩ (< 2.8mΩ*)</td></tr> </table> <p>100% UIS Tested 100% R_g Tested</p> 	V_{DS}	75V	I_D (at $V_{GS}=10V$)	140A	$R_{DS(ON)}$ (at $V_{GS}=10V$)	< 2.6mΩ (< 2.3mΩ*)	$R_{DS(ON)}$ (at $V_{GS}=6V$)	< 3.0mΩ (< 2.8mΩ*)
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Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	75	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ^G	I_D	140	A
		110	
Pulsed Drain Current ^C	I_{DM}	560	A
Continuous Drain Current	I_{DSM}	21.5	A
		17	
Avalanche Current ^C	I_{AS}	120	A
Avalanche energy $L=0.1\text{mH}$ ^C	E_{AS}	720	mJ
Power Dissipation ^B	P_D	500	W
		250	
Power Dissipation ^A	P_{DSM}	2.1	W
		1.3	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 175	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^A	$R_{\theta JA}$	12	15	°C/W
Maximum Junction-to-Ambient ^{A,D}		50	60	°C/W
Maximum Junction-to-Case	$R_{\theta JC}$	0.25	0.3	°C/W

* Surface mount package TO263



AOT270L/AOB270L

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	75			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=75\text{V}, V_{GS}=0\text{V}$ $T_J=55^\circ\text{C}$			1 5	μA
I_{GSS}	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$			± 100	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	2	2.5	3	V
$I_{\text{D(ON)}}$	On state drain current	$V_{GS}=10\text{V}, V_{DS}=5\text{V}$	560			A
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=20\text{A}$		2.1	2.6	$\text{m}\Omega$
		TO220 $T_J=125^\circ\text{C}$		3.3	4.2	
		$V_{GS}=6\text{V}, I_D=20\text{A}$		2.4	3	
		TO220				
		$V_{GS}=10\text{V}, I_D=20\text{A}$		1.9	2.3	
		TO263 $T_J=125^\circ\text{C}$		3.1	3.9	
g_{FS}	Forward Transconductance	$V_{DS}=5\text{V}, I_D=20\text{A}$		80		S
V_{SD}	Diode Forward Voltage	$I_S=1\text{A}, V_{GS}=0\text{V}$		0.66	1	V
I_S	Maximum Body-Diode Continuous Current ^G				140	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=37.5\text{V}, f=1\text{MHz}$		10350		pF
C_{oss}	Output Capacitance			1560		pF
C_{rss}	Reverse Transfer Capacitance			90		pF
R_g	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$	0.4	0.9	1.4	Ω
SWITCHING PARAMETERS						
Q_g	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=37.5\text{V}, I_D=20\text{A}$		153	215	nC
Q_{gs}	Gate Source Charge			33		nC
Q_{gd}	Gate Drain Charge			35		nC
$t_{\text{D(on)}}$	Turn-On Delay Time	$V_{GS}=10\text{V}, V_{DS}=37.5\text{V}, R_L=1.9\Omega$		30		ns
t_r	Turn-On Rise Time			24		ns
$t_{\text{D(off)}}$	Turn-Off Delay Time			80		ns
t_f	Turn-Off Fall Time			32		ns
t_{rr}	Body Diode Reverse Recovery Time	$I_F=20\text{A}, dI/dt=500\text{A}/\mu\text{s}$		45		ns
Q_{rr}	Body Diode Reverse Recovery Charge	$I_F=20\text{A}, dI/dt=500\text{A}/\mu\text{s}$		330		nC

A. The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The Power dissipation P_{DSM} is based on $R_{\theta JA}$ and the maximum allowed junction temperature of 150°C . The value in any given application depends on the user's specific board design, and the maximum temperature of 175°C may be used if the PCB allows it.

B. The power dissipation P_D is based on $T_{J(\text{MAX})}=175^\circ\text{C}$, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature $T_{J(\text{MAX})}=175^\circ\text{C}$. Ratings are based on low frequency and duty cycles to keep initial $T_J=25^\circ\text{C}$.

D. The $R_{\theta JA}$ is the sum of the thermal impedance from junction to case $R_{\theta JC}$ and case to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of $T_{J(\text{MAX})}=175^\circ\text{C}$. The SOA curve provides a single pulse rating.

G. The maximum current limited by package is 140A.

H. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

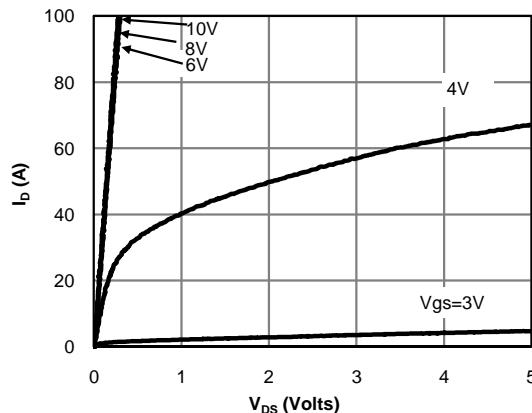


Fig 1: On-Region Characteristics (Note E)

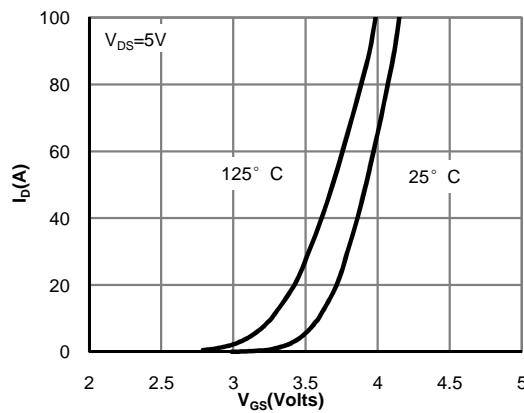


Figure 2: Transfer Characteristics (Note E)

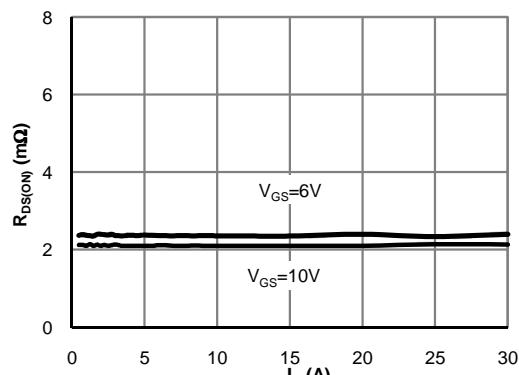


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

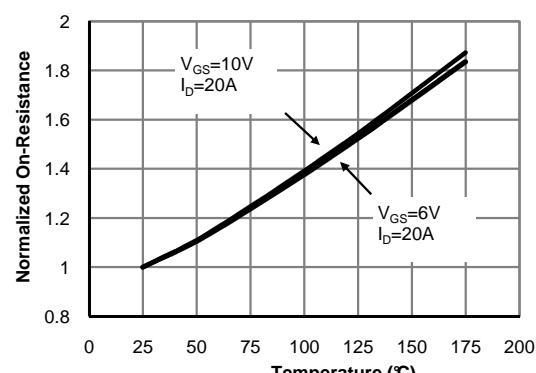


Figure 4: On-Resistance vs. Junction Temperature (Note E)

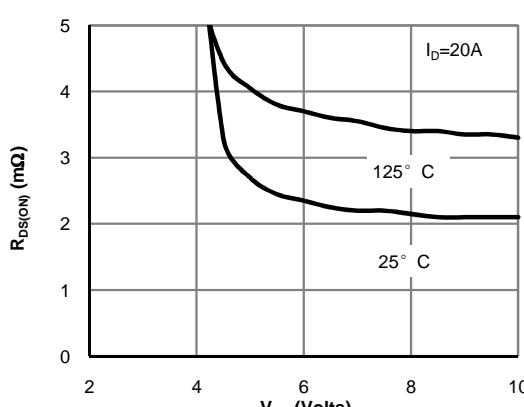


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

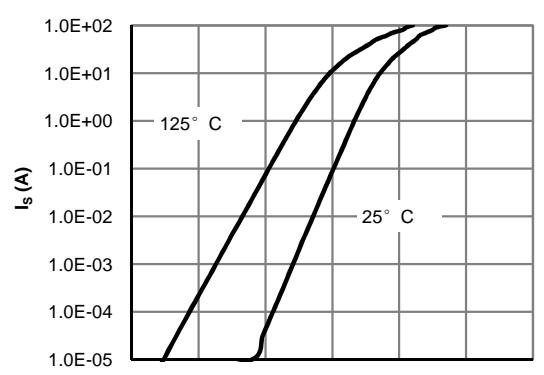
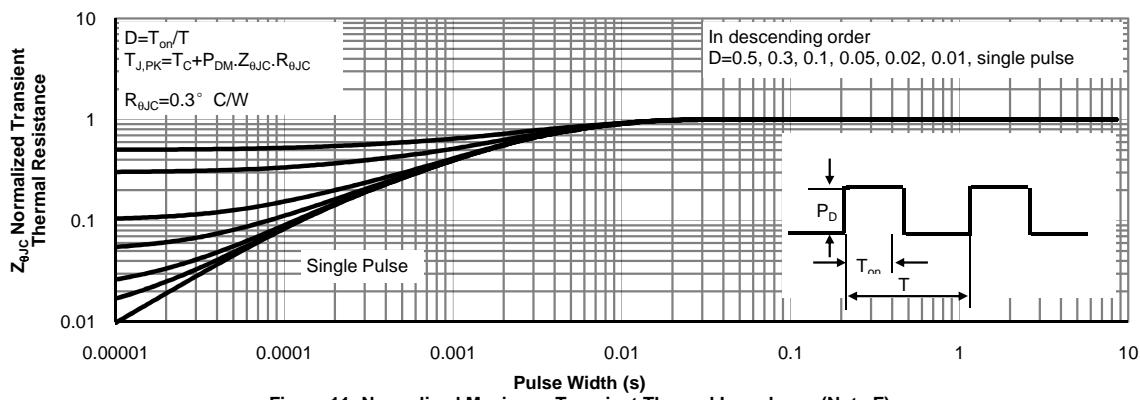
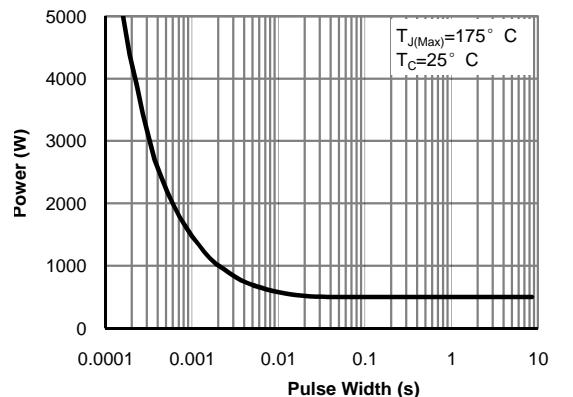
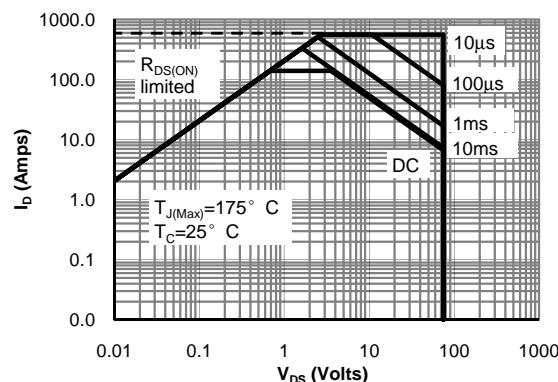
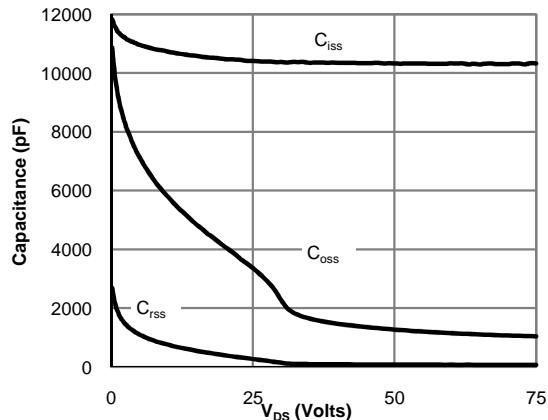
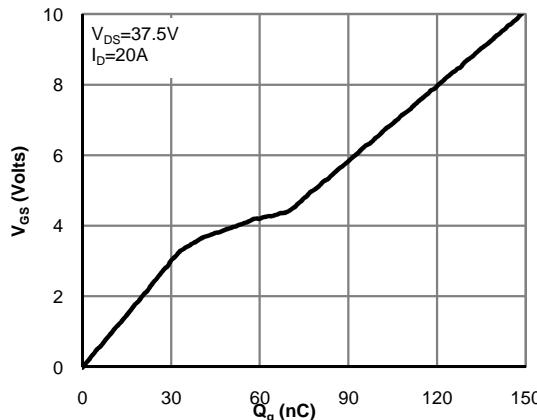


Figure 6: Body-Diode Characteristics (Note E)



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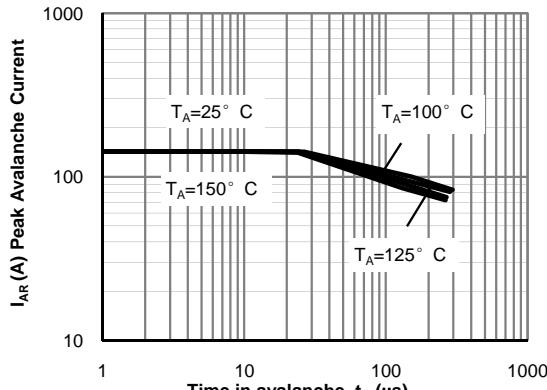


Figure 12: Single Pulse Avalanche capability (Note C)

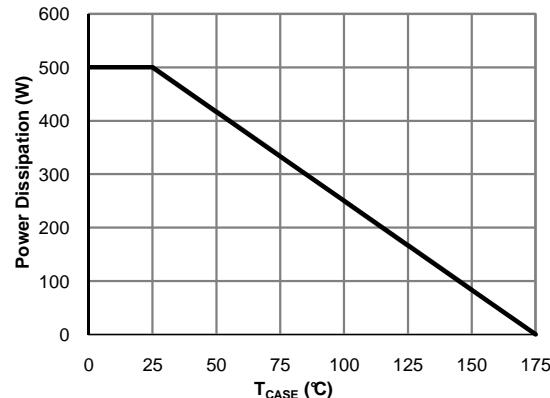


Figure 13: Power De-rating (Note F)

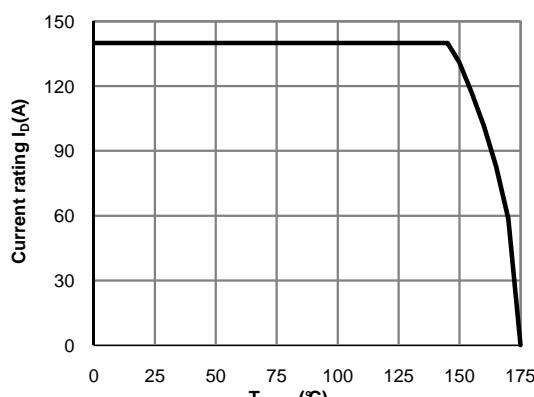


Figure 14: Current De-rating (Note F)

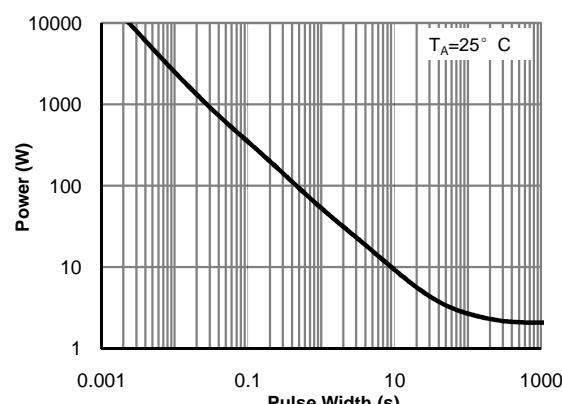


Figure 15: Single Pulse Power Rating Junction-to-Ambient (Note H)

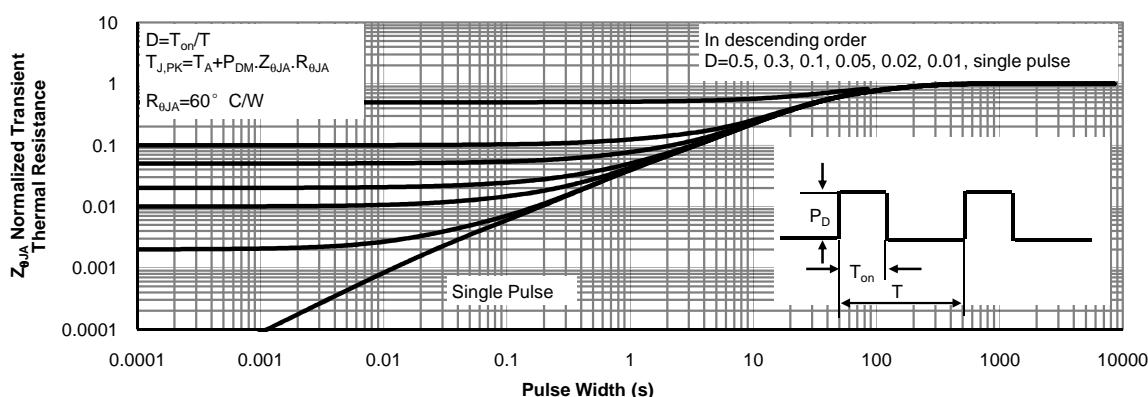


Figure 16: Normalized Maximum Transient Thermal Impedance (Note H)



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